

LNPTM ELCRINTM WF006JiQ

DESCRIPTION

LNP ELCRIN WF006JiQ compound is based on Polybutylene terephthalate (PBT) resin utilizing ELCRIN iQ upcycling technology containing minimum 37% Post-Consumer Recycling (PCR) weight content and 30% glass fiber. Added features of this grade include: Biocompatible (ISO10993), Low Extractables, Healthcare, Excellent Strength, Stiffness and Dimensional Stability.

GENERAL INFORMATION	
Features	Chemical Resistance, Advanced Recycling, Biocompatibility-ISO10993, Healthcare/Formula lock, Dimensional stability, High stiffness/Strength, No PFAS intentionally added (PCR contains <50ppm total organic fluorine content)
Fillers	Glass Fiber (Total fluorine >50ppm only from inorganic fluorine)
Polymer Types	Polybutylene Terephthalate (PBT)
Processing Techniques	Injection Molding

INDUSTRY	SUB INDUSTRY
Building and Construction	Water Management
Consumer	Home Appliances
Hygiene and Healthcare	Pharmaceutical Packaging and Drug Delivery, Surgical devices, General Healthcare, Patient Testing
Packaging	Industrial Packaging

TYPICAL PROPERTY VALUES

Revision 20260901

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
MECHANICAL ⁽¹⁾			
Tensile Stress, yld, Type I, 5 mm/min	114	MPa	ASTM D638
Tensile Stress, brk, Type I, 5 mm/min	114	MPa	ASTM D638
Tensile Strain, yld, Type I, 5 mm/min	2.2	%	ASTM D638
Tensile Strain, brk, Type I, 5 mm/min	2.2	%	ASTM D638
Tensile Modulus, 5 mm/min	11800	MPa	ASTM D638
Flexural Stress, yld, 1.3 mm/min, 50 mm span	210	MPa	ASTM D790
Flexural Stress, brk, 1.3 mm/min, 50 mm span	189	MPa	ASTM D790
Flexural Modulus, 1.3 mm/min, 50 mm span	9100	MPa	ASTM D790
Tensile Stress, yield, 5 mm/min	139	MPa	ISO 527
Tensile Stress, break, 5 mm/min	139	MPa	ISO 527
Tensile Strain, yield, 5 mm/min	1.6	%	ISO 527
Tensile Strain, break, 5 mm/min	1.6	%	ISO 527
Tensile Modulus, 1 mm/min	10700	MPa	ISO 527
Flexural Stress, yield, 2 mm/min	210	MPa	ISO 178
Flexural Modulus, 2 mm/min	9100	MPa	ISO 178
IMPACT ⁽¹⁾			
Izod Impact, unnotched, 23°C	770	J/m	ASTM D4812
Izod Impact, notched, 23°C	82	J/m	ASTM D256
Izod Impact, notched, -30°C	83	J/m	ASTM D256

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
Instrumented Dart Impact Total Energy, 23°C	7	J	ASTM D3763
Izod Impact, notched 80*10*4 +23°C	8	kJ/m ²	ISO 180/1A
Izod Impact, notched 80*10*4 -30°C	8	kJ/m ²	ISO 180/1A
Charpy 23°C, V-notch Edgew 80*10*4 sp=62mm	14	kJ/m ²	ISO 179/1eA
THERMAL ⁽¹⁾			
HDT, 1.8 MPa, 3.2mm, unannealed	203	°C	ASTM D648
HDT, 1.82 MPa, 6.4 mm, unannealed	207	°C	ASTM D648
CTE, -40°C to 40°C, flow	2.5E-05	1/°C	ASTM E831
CTE, -40°C to 40°C, xflow	8.9E-05	1/°C	ASTM E831
CTE, -40°C to 40°C, flow	2.5E-05	1/°C	ISO 11359-2
CTE, -40°C to 40°C, xflow	8.9E-05	1/°C	ISO 11359-2
Ball Pressure Test, approximate maximum	200	°C	IEC 60695-10-2
HDT/Bf, 0.45 MPa Flatw 80*10*4 sp=64mm	217	°C	ISO 75/Bf
Relative Temp Index, Elec ⁽²⁾	140	°C	UL 746B
Relative Temp Index, Mech w/impact ⁽²⁾	140	°C	UL 746B
Relative Temp Index, Mech w/o impact ⁽²⁾	140	°C	UL 746B
PHYSICAL ⁽¹⁾			
Specific Gravity	1.54	-	ASTM D792
Water Absorption, (23°C/24hrs)	0.1	%	ASTM D570
Mold Shrinkage, flow, 3.2 mm ⁽³⁾	0.5 – 0.7	%	SABIC method
Mold Shrinkage, xflow, 3.2 mm ⁽³⁾	0.8 – 1	%	SABIC method
Melt Flow Rate, 250°C/5.0 kgf	52	g/10 min	ASTM D1238
Density	1.54	g/cm ³	ISO 1183
Water Absorption, (23°C/saturated)	0.09	%	ISO 62-1
Moisture Absorption (23°C / 50% RH)	0.1	%	ISO 62
Melt Volume Rate, MVR at 250°C/5.0 kg	38	cm ³ /10 min	ISO 1133
ELECTRICAL ⁽²⁾			
Volume Resistivity	>1E15	Ω.cm	ASTM D257
Dielectric Strength, in air, 3.2 mm	23	kV/mm	ASTM D149
Hot-Wire Ignition (HWI), PLC 2	1.5	mm	UL 746A
High Amp Arc Ignition (HAI), PLC 0	0.45	mm	UL 746A
Comparative Tracking Index (UL) {PLC}	1	PLC Code	UL 746A
High Voltage Arc Track Rate {PLC}	2	PLC Code	UL 746A
FLAME CHARACTERISTICS ⁽²⁾			
UL Yellow Card Link	E45329-104561350	-	-
UL Recognized, 94HB Flame Class Rating	≥0.84	mm	UL 94
INJECTION MOLDING ⁽⁴⁾			
Drying Temperature	120	°C	
Drying Time	3 – 4	Hrs	
Drying Time (Cumulative)	12	Hrs	
Maximum Moisture Content	0.02	%	
Melt Temperature	250 – 265	°C	
Nozzle Temperature	245 – 265	°C	
Front - Zone 3 Temperature	250 – 265	°C	
Middle - Zone 2 Temperature	245 – 260	°C	

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
Rear - Zone 1 Temperature	240 – 255	°C	
Mold Temperature	65 – 90	°C	
Back Pressure	0.3 – 0.7	MPa	
Screw Speed	50 – 80	rpm	
Shot to Cylinder Size	40 – 80	%	
Vent Depth	0.025 – 0.038	mm	

- (1) The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.
- (2) UL Ratings shown on the technical datasheet might not cover the full range of thicknesses and colors. For details, please see the UL Yellow Card.
- (3) Measurements made from laboratory test coupon. Actual shrinkage may vary outside of range due to differences in processing conditions, equipment, part geometry and tool design. It is recommended that mold shrinkage studies be performed with surrogate or legacy tooling prior to cutting tools for new molded article.
- (4) Injection Molding parameters are only mentioned as general guidelines. These may not apply or may need adjustment in specific situations such as low shot sizes, large part molding, thin wall molding and gas-assist molding.

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